



COPY OF PAPER
ORIGINALLY FILED

28/1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: John T. Moore et al. § Group Art Unit: 2811
Serial No.: 09/496,794 § Examiner: Douglas Owens
Filed: February 2, 2000 § Atty. Dkt. No.: MCT-0005-D1-US
For: Trench Isolation for 97-0608
Semiconductor Devices

#1510
Andy
J. Marville
9/11/02

Commissioner for Patents
Washington DC 20231

REPLY TO PAPER NO. 14

Sir:

In response to the office action mailed July 31, 2002, please amend the application as follows:

IN THE CLAIMS

Please cancel claims 31-34.

REMARKS

The pending claims 26-30 were rejected under § 103 over the patent to Fazan that is assigned to Micron Technology, Inc. as is the present application. Moreover, the Fazan patent issued less than a year before the filing date of this application. Therefore under 35 U.S.C. § 103(c), the Fazan patent cannot be used to fashion a § 103 rejection of the present application.

See M.P.E.P. § 2146.

RECEIVED
SEP -9 2002
TECHNOLOGY CENTER 2800

Date of Deposit: August 21, 2002
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, Washington DC 20231.
Cynthia L. Hayden
Cynthia L. Hayden